

# SAFA Screenshots

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## Full App Sections

The screenshot displays the 'Full Application' section of the SAFA interface. At the top right, it shows the OMB Control Number (0693-0094) and the Expiration Date (09/30/2023). A 'View Burden Statement' button is located in the top right corner. Below this, a list of application sections is shown, each with a 'SECTION STATUS' of 'Not Started'. A 'Get Started' button is visible next to the 'Acknowledgement' section.

Section Name	SECTION STATUS
Acknowledgement	Not Started
Cover Page	Not Started
Project Plan	Not Started
Sources and Uses	Not Started
CHIPS Incentive Request	Not Started
Workforce Development Information	Not Started
File Uploads	Not Started
Attestation & Submission	Not Started

# Burden Statement

The screenshot shows a web form titled "Burden Statement" with a close button (X) in the top right corner. The text explains that a Federal agency may not conduct or sponsor, and a person is not required to respond to, nor shall a person be subject to a penalty for failure to comply with an information collection subject to the requirements of the Paperwork Reduction Act of 1995 unless the information collection has a currently valid OMB Control Number. The approved OMB Control Number for this information collection is 0693-0094. Without this approval, the agency could not conduct this information collection. Public reporting for this information collection is estimated to be approximately 125 hours per response, including the time for reviewing instructions, searching existing data sources, gathering and maintaining the data needed, and completing and reviewing the information collection. All responses to this information collection are required to obtain benefits. Send comments regarding this burden estimate or any other aspect of this information collection, including suggestions for reducing this burden to the National Institute of Standards and Technology at: [askchips@chips.gov](mailto:askchips@chips.gov). At the bottom of the form, there is a "SECTION STATUS" label and a "Submit" button.

# Acknowledgement

The screenshot shows a web form titled "Acknowledgement" with a close button (X) in the top right corner. The text states: "Any communication, data, or other information stored or transmitted on this system may be accessed and used by federal employees, consultants and contractors in accordance with Section IV.C. of the CHIPS Incentives Program – Commercial Fabrication Facilities Notice of Funding Opportunity (CHIPS-CFF NOFO). By voluntarily furnishing information through this system, the applicant consents to such access and use." Below the text is a checkbox labeled "I acknowledge the above statement" which is checked. At the bottom right of the form is a blue "Next" button.

# Cover Page

## Cover Page

### ✓ View Confidentiality Statement

Consistent with the Notice of Funding Opportunity (NOFO) for the CHIPS Incentives Program – Commercial Fabrication Facilities, NIST will treat the submitted information as confidential business information (CBI). As a result, NIST will strive to protect the submitted information by applying controls commensurate with the FIPS-199 high for confidentiality level. Information that is populated in structured questions will automatically be labeled as Controlled Unclassified Information – confidential business information (CU//PROPIN). When uploading free form documents, you are responsible for marking those documents for CBI. Please see the instructions and legend language set forth in the NOFO at section IV.C.2. Proper markings on all submitted information will assist the Department in ensuring protection from disclosure as provided by 15 U.S.C. 4652 (with certain exceptions) and Exemptions 3 and/or 4 of the Freedom of Information Act, 5 U.S.C. 552, as applicable. Please see section IV.C.1 of the NOFO for further information regarding confidentiality.

Complete the CHIPS Program Cover Page questions with the following information regarding the proposed application. The information submitted should be consistent with the information provided in the Statement of Interest. Instructions for how to complete the form are located here: <https://www.nist.gov/document/chips-nofo-commercial-fabrication-facilities-pre-application-instructions>.

Be sure to include any statements regarding the confidentiality of information contained within the Pre-application, in accordance with Section IV.C of the NOFO.

\* Name of Application

## Steps

- Cover Page
- Cover Page
- Generate PDF

(Cover Page step 1)

## Potential Applicant Organization Information

Provide the legal name of the entity applying for CHIPS Incentives. Note, this is not the name of the individual submitting the application.

\* Potential Applicant Name (e.g., applying entity)

Apple

Corporate Parent Name

\* Street 1

1010 Main

Street 2

\* Country/Area

United States

\* City

Highland

\* State

Arizona

\* Postal Co...

43444-01

\* Organization Website

https://w.w.com

Is the applicant a consortium?

\* Response

No

Have you registered for a [SAM.gov](https://sam.gov) account?

\* Response

Yes

UEI # (Optional)

Save and

Next

(Cover Page step 1 continued)

# Cover Page

## Applicant Point of Contact

Please enter information for the applicant point of contact, who should be an individual authorized to submit an application on behalf of the entity.

* First Name	* Last Name	
<input type="text" value="Dwayne"/>	<input type="text" value="The Rock Johnson"/>	
* Title	* Phone Number	* Email Address
<input type="text" value="Owner"/>	<input type="text" value="2342342344"/>	<input type="text" value="jeb.griffin+22@salesforc"/>

## Partnering Entities, if applicable

Are there other entities (e.g., customers, suppliers, investors, advisors) you anticipate partnering with in a meaningful way?

\* Response

### Attestation

Elements of this statement have been prepopulated with data submitted previously. I have reviewed the information to be submitted for accuracy and made updates where necessary.

\*

## Steps

- ✓ Cover Page
- Cover Page
- Generate PDF

(Cover Page step 2)

## Generate PDF

Your pdf is generating and can be found in the Submissions tab. Please do not exit this screen until it is complete.



### Steps

- ✓ Cover Page
- ✓ Cover Page
- Generate PDF

(Cover page PDF)

# Project Plan

## Project(s) Information

### View Confidentiality Statement

Consistent with the Notice of Funding Opportunity (NOFO) for the CHIPS Incentives Program – Commercial Fabrication Facilities, NIST will treat the submitted information as confidential business information (CBI). As a result, NIST will strive to protect the submitted information by applying controls commensurate with the FIPS-199 high for confidentiality level. Information that is populated in structured questions will automatically be labeled as Controlled Unclassified Information – confidential business information (CUI//PROPIN). When uploading free form documents, you are responsible for marking those documents for CBI. Please see the instructions and legend language set forth in the NOFO at section IV.C.2. Proper markings on all submitted information will assist the Department in ensuring protection from disclosure as provided by 15 U.S.C. 4652 (with certain exceptions) and Exemptions 3 and/or 4 of the Freedom of Information Act, 5 U.S.C. 552, as applicable. Please see section IV.C.1 of the NOFO for further information regarding confidentiality.

Instructions for how to complete these questions are located here: <https://www.nist.gov/document/chips-nofo-commercial-fabrication-facilities-pre-application-instructions>

Project(s) Description, i.e. description of the construction, expansion, or modernization activities for each proposed facility at a single location; resulting products that will be manufactured, along with information on the scale, size, and capacity of production, and any known timelines (max. 3000 characters)

\* Response ⓘ

Project(s) Description, i.e. description of the construction, expansion, or modernization activities for each proposed facility at a single location; resulting products that will be manufactured, along with information on the scale, size, and capacity of production, and any known timelines (max. 3000 characters)

Product End Market Application, i.e., description of the types of customers and which end markets will be served by the technology being produced from each proposed facility (max. 500 characters)

\* Response ⓘ

Product End Market Application, i.e., description of the types of customers and which end markets will be served by the technology being produced from each proposed facility (max. 500 characters)

## Steps

- Project(s) Information
- Facilities Information
- Generate PDF

(Project plan step 1)

Site Location

\* City

Highland

\* State

Alabama

\* ZIP Code

44444-0000

Expected Total Capital Expenditures for all proposed projects -  
Please provide the narrowest range possible:

\* Minimum

\$ 3

\* Maximum

\$ 3

Optional commentary on range provided for Expected Total Capital Expenditures (max. 500 characters)

Response

Estimated peak monthly unit production capacity (e.g. wafers  
per month, components per month)

\* Quantity

3

Not Applicable

Please specify unit used

\* Units

3

Attestation

Elements of this statement have been prepopulated with data submitted previously. I have reviewed the information to be submitted for accuracy and made updates where necessary.

\*

Next

(Project plan step 1 continued)



## Facilities Information

Instructions for how to complete these questions are located here: <https://www.nist.gov/document/chips-nofo-commercial-fabrication-facilities-pre-application-instructions>

According to the NOFO, an application may include one or more facilities that are / will be on the same site.

For each facility for this application, click 'Add New Facility'

Total Number of Facilities: 0

<input type="checkbox"/>	Name	Facility ...	Tech Ty...	Const. Start	Prod. Start
--------------------------	------	--------------	------------	--------------	-------------

+ Add New Facility

A "facility" used in the context of this application refers to a leading-edge, current-generation, or mature-node facility, or a back-end production facility. Please refer to the NOFO Section I.B.1 for additional description of fabricating and packaging facilities covered by this NOFO.

Previous

Finish

## Steps

- Project(s) Information
- Facilities Information**
- Generate PDF

(Project plan step 2)

+ Add New Facility

\* Name

\* Project Type

--Select--

\* Facility Type

--Select--

Construction of New Facil...

Expansion or Modernizati...

Both

\* Facility Peak Capacity

\* Facility Peak Unit

\* Description

Please include whether the activities at the facility will be construction, expansion, or modernization and information on the scale...

Close Save

(Project Type)

+ Add New Facility

\* Name

\* Project Type

\* Facility Type

Complete this field.

\* Construction Start

\* Facility Peak Capacity

\* Description

Please include whether the services at the facility will be construction, expansion, or modernization and information on the scale.

- Leading-Edge Facilities
- Current-Generation Facili...
- Mature Node Facilities
- Back-End Production Faci...
- Semiconductor Materials ...
- Research and Developme...
- Other

Close

Save

(Facility Type)

\* Name  
Site 1

\* Project Type  
Both ▼

\* Facility Type  
Current-Gener... ▼

Technology Type  
Mixed-signal devices (up to 28 nm) ▼

\* Construction Start  
Jul 7, 2023 📅

\* Production Start  
Oct 6, 2023 📅

\* Facility Peak Capacity  
152

\* Facility Peak Unit  
wf

\* Description  
Description

Close Save

A "facility" used in the context of this application refers to a leading-edge, current-generation, or mature-node facility, or a back-end production facility. Please refer to the NOFO Section I.B.1 for additional description of fabricating and packaging facilities covered by this NOFO.

(Adding new facility)

## Facilities Information

Instructions for how to complete these questions are located here: <https://www.nist.gov/document/chips-nofo-commercial-fabrication-facilities-pre-application-instructions>

According to the NOFO, an application may include one or more facilities that are / will be on the same site.

For each facility for this application, click 'Add New Facility'

Total Number of Facilities: 1

<input type="checkbox"/>	Name	Facility ...	Tech Ty...	Const. Start	Prod. Start
1 <input type="checkbox"/>	Site 1	Current-Ge...	Mixed-signa...	07/07/2023	10/06/2023

Delete Facilities

+ Add New Facility

A "facility" used in the context of this application refers to a leading-edge, current-generation, or mature-node facility, or a back-end production facility. Please refer to the NOFO Section I.B.1 for additional description of fabricating and packaging facilities covered by this NOFO.

Previous

Finish

## Steps

- Project(s) Information
- Facilities Information
- Generate PDF

(Project Plan step 2 continued)

## Generate PDF

Your pdf is generating and can be found in the Submissions tab. Please do not leave this screen until it is complete.



## Steps

- Project(s) Information
- Facilities Information
- Generate PDF

(Project Plan section complete)

# Sources and Uses

## Uses of Funds Form

### View Confidentiality Statement

Consistent with the Notice of Funding Opportunity (NOFO) for the CHIPS Incentives Program – Commercial Fabrication Facilities, NIST will treat the submitted information as confidential business information (CBI). As a result, NIST will strive to protect the submitted information by applying controls commensurate with the FIPS-199 high for confidentiality level. Information that is populated in structured questions will automatically be labeled as Controlled Unclassified Information – confidential business information (CUI//PROPIN). When uploading free form documents, you are responsible for marking those documents for CBI. Please see the instructions and legend language set forth in the NOFO at section IV.C.2. Proper markings on all submitted information will assist the Department in ensuring protection from disclosure as provided by 15 U.S.C. 4652 (with certain exceptions) and Exemptions 3 and/or 4 of the Freedom of Information Act, 5 U.S.C. 552, as applicable. Please see section IV.C.1 of the NOFO for further information regarding confidentiality.

Complete the summarized project sources and uses. Please ensure values for sources and uses match numbers submitted in the uploaded document in the "Summation across projects" sheet as well as the CHIPS Incentives request form.

### Schedule A: Summation Across Projects – Cost Schedule (\$ USD)

1. Capital Investment	<input type="text"/>
2. Operating losses and other cash outflows until project cash flows breakeven	<input type="text"/>
3. Workforce Development Costs	<input type="text"/>
4. Other Uses of Funds	<input type="text"/>
Total Project Costs	<input type="text" value="\$ 0.00"/>

Next

## Steps

- Uses of Funds Form
- Sources of Funds Form
- Sources of Funds Form (continued)
- Generate PDF

(Sources and Uses step 1)

# Sources of Funds Form

Complete the summarized project sources and uses. Please ensure values for sources and uses match numbers submitted in the uploaded document in the "Summation across projects" sheet as well as the CHIPS Incentives request form.

## Schedule B: Summation Across Projects – Sources Schedule (\$ USD)

<b>1. Equity Funding</b>	<input type="text" value="\$ 303.00"/>
1a. Sponsor Equity (Applicant and/or Corporate Parent)	<input type="text" value="\$ 100"/>
1b. Third-Party Equity	<input type="text" value="\$ 101"/>
1c. Other Equity Funding	<input type="text" value="\$ 102"/>
<b>2. Debt Funding</b>	<input type="text" value="\$ 418.00"/>
2a. Sponsor Debt	<input type="text" value="\$ 103"/>
2b. Third-Party Debt (e.g., Bonds or Loans)	<input type="text" value="\$ 104"/>
2c. Unguaranteed portion of Third-Party Loans Guaranteed by CHIPS Program	<input type="text" value="\$ 105"/>
2d. Other Debt Funding	<input type="text" value="\$ 106"/>

[Previous](#) [Next](#)

### Steps

- Uses of Funds Form
- Sources of Funds Form
- Sources of Funds Form (continued)
- Generate PDF

(Sources and uses step 2)

## Sources of Funds Form (continued)

Complete the summarized project sources and uses. Please ensure values for sources and uses match numbers submitted in the uploaded document in the "Summation across projects" sheet as well as the CHIPS Incentives request form.

### Schedule B: Summation Across Projects – Sources Schedule (\$ USD)

<b>3. Government Support</b>	\$ 550.00
3a. Anticipated CHIPS Direct Funding Request	\$ 108
3b. Anticipated CHIPS Loan Request	\$ 109
3c. Guaranteed portion of Third-Party Loans Expected to be Guaranteed by CHIPS Program	\$ 110
3d. Investment Tax Credit (estimated)	\$ 111
3e. State and Local Government Incentives (Grants + Loans + Tax Credits)	\$ 112
<b>4. Other Sources of Funds</b>	\$ 113
<b>Total Project Funding</b>	\$ 1,384.00

Attestation

Elements of this statement have been prepopulated with data submitted previously. I have reviewed the information to be submitted for accuracy and made updates where necessary.

[Previous](#) [Next](#)

## Steps


- ✓ Uses of Funds Form
- ✓ Sources of Funds Form
- Sources of Funds Form (continued)
- Generate PDF

(Sources and Uses step 3)

Completed

## Generate PDF

Your pdf is generating and can be found in the Submissions tab. Please do not leave this screen until it is complete.



## Steps

- ✓ Uses of Funds Form
- ✓ Sources of Funds Form
- ✓ Sources of Funds Form (continued)
- Generate PDF

(Sources and Uses complete)

# CHIPS Incentive Request

## CHIPS Incentives Requests

### View Confidentiality Statement

Consistent with the Notice of Funding Opportunity (NOFO) for the CHIPS Incentives Program – Commercial Fabrication Facilities, NIST will treat the submitted information as confidential business information (CBI). As a result, NIST will strive to protect the submitted information by applying controls commensurate with the FIPS-199 high for confidentiality level. Information that is populated in structured questions will automatically be labeled as Controlled Unclassified Information – confidential business information (CUI//PROPIN). When uploading free form documents, you are responsible for marking those documents for CBI. Please see the instructions and legend language set forth in the NOFO at section IV.C.2. Proper markings on all submitted information will assist the Department in ensuring protection from disclosure as provided by 15 U.S.C. 4652 (with certain exceptions) and Exemptions 3 and/or 4 of the Freedom of Information Act, 5 U.S.C. 552, as applicable. Please see section IV.C.1 of the NOFO for further information regarding confidentiality.

Complete the CHIPS Program Incentive Request form below in the application portal as it pertains to the projects overall. Information submitted in this form should correspond with figures uploaded in Sources & Uses template and form submission. To the extent that requested terms differ from the baseline terms in Section I.B.8 of the NOFO, the summary should include a justification.

Are you requesting Direct Funding?

\* Select from drop-down

Are you requesting a CHIPS Loan?

\* Select from drop-down

Are you requesting a CHIPS Loan Guarantee?

\* Select from drop-down

Next

## Steps

- CHIPS Incentives Requests
- CHIPS Direct Funding Request
- CHIPS Loans Request
- CHIPS Loan Guarantee Request
- Credit Rating
- Generate PDF

(CHIPS Incentive Requests step 1)



## CHIPS Direct Funding Request

Complete the CHIPS Program Incentive Request form below in the application portal as it pertains to the projects overall. Information submitted in this form should correspond with figures uploaded in Sources & Uses template and form submission. To the extent that requested terms differ from the baseline terms in Section I.B.8 of the NOFO, the summary should include a justification.

Amount requested for CHIPS Direct Funding

\* In USD

\$ 1,052

Previous

Next

### Steps

- ✓ CHIPS Incentives Requests
- CHIPS Direct Funding Request
- CHIPS Loans Request
- CHIPS Loan Guarantee Request
- Credit Rating
- Generate PDF

(CHIPS Direct Funding Request)

## CHIPS Loans Request

Complete the CHIPS Program Incentive Request form below in the application portal as it pertains to the projects overall. Information submitted in this form should correspond with figures uploaded in Sources & Uses template and form submission. To the extent that requested terms differ from the baseline terms in Section I.B.8 of the NOFO, the summary should include a justification.

Amount requested for the CHIPS Loan

\* In USD

\$ 101

Requested tenor for the CHIPS Loan

\* Number of months

52

Financing Structure

\* Select from drop-down

Project Finance

Optionally, provide other requested terms for the requested CHIPS loan (e.g., details on amortization schedule, deferred interest option, pre-payment, seniority, collateralization, fixed vs floating interest rate type). To the extent that requested terms differ from the baseline terms in Section I.B.8 of the NOFO, the summary should include a justification.

Response

Optionally, provide other requested terms for the requested CHIPS loan (e.g., details on amortization schedule, c

Previous

Next

### Steps

- ✓ CHIPS Incentives Requests
- ✓ CHIPS Direct Funding Request
- CHIPS Loans Request
- CHIPS Loan Guarantee Request
- Credit Rating
- Generate PDF

(CHIPS Loan Request)

## CHIPS Loan Guarantee Request

Complete the CHIPS Program Incentive Request form below in the application portal as it pertains to the projects overall. Information submitted in this form should correspond with figures uploaded in Sources & Uses template and form submission. To the extent that requested terms differ from the baseline terms in Section I.B.8 of the NOFO, the summary should include a justification.

### Loan Guarantee Summary (Calculated)

Third-Party Loan Guaranteed by CHIPS program \$0  
Unguaranteed portion of Third-Party Loan Guaranteed by CHIPS Program \$0

### CHIPS Loan Guarantee Request Details

<input type="checkbox"/>	Total siz... ▾	Amount ... ▾	Expecte... ▾	Third Pa... ▾	Addition... ▾
--------------------------	----------------	--------------	--------------	---------------	---------------

+ Add Loan Guarantee

Previous

Next

### Steps

- ✓ CHIPS Incentives Requests
- ✓ CHIPS Direct Funding Request
- ✓ CHIPS Loans Request
- CHIPS Loan Guarantee Request
- Credit Rating
- Generate PDF

(CHIPS Loan guarantee Request)

+ Add Loan Guarantee

\* Total size of the loan

\$159,652.00

Third Party Lender, if known (please include all if multiple)

Chase

\* Amount of expected Loan request to be guaranteed through CHIPS program (up to 80%)

\$10,000.00

\* Expected Tenor of the Loan

105

Additional Information

Additional info

Save

Cancel

(Loan Guarantee)

# CHIPS Loan Guarantee Request

Complete the CHIPS Program Incentive Request form below in the application portal as it pertains to the projects overall. Information submitted in this form should correspond with figures uploaded in Sources & Uses template and form submission. To the extent that requested terms differ from the baseline terms in Section I.B.8 of the NOFO, the summary should include a justification.

## Loan Guarantee Summary (Calculated)

Third-Party Loan Guaranteed by CHIPS program \$10000  
Unguaranteed portion of Third-Party Loan Guaranteed by CHIPS Program \$149652

## CHIPS Loan Guarantee Request Details

<input type="checkbox"/>	Total siz... ▾	Amount ... ▾	Expecte... ▾	Third Pa... ▾	Addition... ▾
1	<input type="checkbox"/> \$159,65...	\$10,000....	105	Chase	Additio...

Delete Loan Guarantee

+ Add Loan Guarantee

Previous

Next

## Steps

- ✓ CHIPS Incentives Requests
- ✓ CHIPS Direct Funding Request
- ✓ CHIPS Loans Request
- CHIPS Loan Guarantee Request
- Credit Rating
- Generate PDF

(CHIPS Loan guarantee added)

<input type="checkbox"/>	Credit Rating ... ▾	Agency Provi... ▾	Corporate Cre... ▾	Date of Rating
<p>+ Add Credit Rating</p>				
* Credit Rating Entity Type				
<input type="text" value="Borrowing Entity"/>				
* Agency Providing Credit Rating		* Corporate Credit Rating		
<input type="text" value="BOA"/>		<input type="text" value="AAA"/>		
* Date of Rating				
<input type="text" value="May 30, 2023"/>				
<p>Cancel</p>		<p>Save</p>		

(Credit Rating)

<input type="checkbox"/>	Credit Rating ...	Agency Providi...	Corporate Cre...	Date of Rating
1	<input type="checkbox"/> Borrowing Entity	BOA	AAA	05/30/2023


**Delete Credit Ratings**      **+ Add Credit Rating**

[Previous](#)      [Next](#)

(Added credit rating)

### Generate PDF

Your pdf is generating and can be found in the Submissions tab. Please do not exit this screen until it is complete.



### Steps

- CHIPS Incentives Requests
- CHIPS Direct Funding Request
- CHIPS Loans Request
- CHIPS Loan Guarantee Request
- Credit Rating
- Generate PDF

(CHIPS Incentive Request Completed)

# Workforce Development Information

## Workforce Development Information

View Confidentiality Statement

Consistent with the Notice of Funding Opportunity (NOFO) for the CHIPS Incentives Program – Commercial Fabrication Facilities, NIST will treat the submitted information as confidential business information (CBI). As a result, NIST will strive to protect the submitted information by applying controls commensurate with the FIPS-199 high for confidentiality level. Information that is populated in structured questions will automatically be labeled as Controlled Unclassified Information – confidential business information (CUI//PROPIN). When uploading free form documents, you are responsible for marking those documents for CBI. Please see the instructions and legend language set forth in the NOFO at section IV.C.2. Proper markings on all submitted information will assist the Department in ensuring protection from disclosure as provided by 15 U.S.C. 4652 (with certain exceptions) and Exemptions 3 and/or 4 of the Freedom of Information Act, 5 U.S.C. 552, as applicable. Please see section IV.C.1 of the NOFO for further information regarding confidentiality.

Instructions for completing this form are located here: <https://www.nist.gov/document/chips-nofo-commercial-fabrication-facilities-pre-application-instructions> ;

Provide an estimate of the number of jobs that will be created during the construction phase of the project(s). Do not include any jobs that will be performed outside of the United States.

Direct jobs on the construction site(s): Enter an estimate for the number of jobs that will be directly involved in the construction activities for the construction, expansion, or modernization of a facility. Examples include laborers and foremen for construction activities.

\* Number ... ⓘ

Error: Number of jobs is required.

Indirect jobs: Enter an estimate for the number of jobs that will be indirectly involved in the construction activities for the construction, expansion, or modernization of a facility. Examples include contracted equipment suppliers and technicians, architects and engineers consulted.

\* Number ... ⓘ

Provide an explanation of your job creation estimates above. Provide any assumptions, sources, or other explanations for the estimates included for direct or indirect jobs created.

\* Response


### Steps

- Workforce Development Information
- Generate PDF


(Workforce Development Information step 1)

Provide an estimate of the number of jobs that will be created during the production phase of the project(s). Do not include any jobs that will be performed outside of the United States.

Direct jobs in production: Enter an estimate for the number of jobs that will be directly involved in the operation of the facility or facilities. This includes all employees of the entity that will be onsite for activities relating to manufacturing, overhead, research & development, and administration.

\* Number ... 

Indirect jobs: Enter an estimate for the number of jobs that will be created in the broader ecosystem as a result of operating the facility or facilities. Examples include incremental needs for materials suppliers (e.g., silicon, chemicals, consumables), utilities suppliers, contractors for equipment needs (e.g., cleaning and repair), product transport, etc.

\* Number ... 

Provide an explanation of your job creation estimates above. Provide any assumptions, sources, or other explanations for the estimates included for direct or indirect jobs created.

\* Response

Provide an explanation of your job creation estimates above. Provide any assumptions, sources, or other explanations for the estimates included for direct or indirect jobs created.

Attestation

I have reviewed the workforce development information for accuracy and made any necessary updates.


[Save](#)

(Workforce Development Information step 1 continued)

In Progress

## Generate PDF

Your pdf is generating and can be found in the Submissions tab. Please do not exit this screen until it is complete.



### Steps




- Workforce Development Information
- Generate PDF

(Workforce Development Information completed)

# File Uploads

## CHIPS Full Application









Use 'Save Progress' if not all documents are uploaded. Once all required and optional documents have been uploaded click 'File Upload Complete'.

-  Documents Uploaded
-  Documents Optional
-  Documents Required

Save Progress


File Upload Complete

Required File Count: 0/26

Status	Name	Required Documents	Optional Documents
<b>Covered Incentive</b>			
▼ 	Covered Incentive	0/1	0
<b>Project Plan</b>			
▼ 	Description of Project(s)	0/1	0
<b>Applicant Profile</b>			
▼ 	Descriptive Information About the Applicant	0/1	0
▼ 	Company Financials	0/1	0
▼ 	Equity Capital Structure	0/1	0
▼ 	Outstanding Debt	0/1	0
<b>Alignment with Economic Resilience and National Security Objectives</b>			
▼ 	Alignment with Economic and National Security Objectives	0/1	0
<b>Commercial Strategy</b>			
▼ 	Commercial Strategy	0/1	0


# Covered Incentive

## Covered Incentive


^  Covered Incentive 0/1 0

Please provide at least one letter from state or local government entity to demonstrate that the applicant has been offered a qualifying covered incentive, indicating the estimated size and nature of the incentive. The offer of a covered incentive may be contingent; however, any contingencies need to clearly be specified in the letter.

Required File Upload

 Or drop files Upload one PDF that addresses the instructions above

Optional File Upload


 Or drop files Upload additional or supporting documents

File Name	Upload Date	Required
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# Project Plan

## Project Plan


^  Description of Project(s) 0/1 0

Provide a detailed description of proposed project(s) in the application. The submission should be responsive to the program description (see section I of the NOFO) and the Evaluation Criteria (see section V.A. of the NOFO). There should be an overarching description of the vision for all projects (no more than 15 pages long), as well as a description of each project (no more than 15 pages each, excluding supporting attachments and appendices that substantiate information in the narrative section). The description should contain the following information, as outlined in section IV.I.3. in the NOFO:


- Description of Project(s)
- Consortium Description (if applicable)
- Cluster Profile
- Project Timeline
- Summary Narrative Addressing Evaluation Criteria
- CHIPS Incentives Justification

In addition to the detailed description of proposed project(s), please attach any supporting documents that may be relevant, including additional documents that describe each individual project in the application (if relevant).

Required File Upload

 Or drop files Upload one PDF that addresses the instructions above

Optional File Upload

 Or drop files Upload additional or supporting documents

File Name	Upload Date	Required
-----------	-------------	----------

# Applicant Profile

## Applicant Profile

Descriptive Information About the Applicant 1/1 0

Provide information about the applicant as detailed in the NOFO, Section IV.I.4. If applicable, also provide this information for the applicant's ultimate corporate parent and any key intermediate entities within the organizational structure of the project.

Please include information related to the applicant's businesses, including but not limited to company name, corporate form, jurisdiction of formation, description of key business activities, year established, headquarters country/state/city, countries/U.S. states of operation, and number of employees.

In addition, the application should include a brief description of the company's business profile, key products manufactured, end markets, and competitors, as well as any existing or planned business operations in foreign countries of concern.

Required File Upload

Upload one PDF that addresses the instructions above

Optional File Upload

Upload additional or supporting documents

File Name	Upload Date	Required	
CHIPS-000886-ApplicantDescription-Company Financials-20230530	5/30/2023	✓	

## Applicant Profile

▼	✓	Descriptive Information About the Applicant	1/1	0
▲	✓	Company Financials	1/1	0

If available, upload audited consolidated financial reporting statements for the applicant at fiscal year-end for each of the last five years, and interim financial statements for the current fiscal year.

If available, this should include key financial metrics including margin, free cash flow and return information, leverage, debt service coverage, and related ratios, such as interest coverage ratios, fixed charge coverage ratios, debt to capital ratios, Debt/EBITDA ratios, asset coverage ratios, and working capital ratios.

If available, applicants should also include nationally recognized statistical ratings organization (NRSRO) ratings, as well as their latest rating reports.

If applicable, also provide all above the information for the applicant's ultimate corporate parent and any key intermediate entities within the organizational structure of the project.

Note: To the extent that audited financial statements are not available for any particular entity, please provide unaudited internal financial statements and key financial metrics.

### Required File Upload


 Or drop files

Upload one PDF or Excel that addresses the instructions above

### Optional File Upload

 Or drop files

Upload additional or supporting documents (PDF or Excel)

File Name	▼	Upload Date	Required	
CHIPS-000886-APCompanyFinancials-Key Assumptions-20230530		5/30/2023	✓	



Provide a schedule listing the applicant's outstanding debt, lines of credit, other material indebtedness, guarantees, or (material) off-balance sheet liabilities, along with the expected cost for those liabilities. In addition, provide a description of any planned debt issuances (including as related to the application) for the applicant. Also provide any cash information and net debt calculations.

If applicable, provide the above information for the applicant's ultimate corporate parent and any key intermediate entities within the organizational structure of the project.

Required File Upload

Upload Files Or drop files

Upload one PDF or Excel that addresses instructions above

Optional File Upload

Upload Files Or drop files

Upload additional or supporting documents

File Name	Upload Date	Required	
CHIPS-000886-APOutstandingDebt-Sources and Instruction Guide-20230530	5/30/2023	✓	



# Alignment with Economic Resilience and National Security Objectives

## Alignment with Economic Resilience and National Security Objectives



Alignment with Economic and National Security Objectives

0/1

0

Provide a description in no more than 30 pages (excluding supporting attachments and appendices) of how the project(s) meet economic and national security objectives. This should address the program priorities in Section I.C.1., as applicable, and merit review criteria in Section V.A.1 of the NOFO, including how the project(s) will, both individually and collectively:

- Enhance U.S. economic competitiveness by credibly committing to make ongoing private investments in the U.S. and creating a long-term, sustainable ecosystem
- Increase global supply chain resilience by mitigating the risk of potential shocks, reducing the impact of potential disruptions, serving a variety of customers, and moving production outside of countries of concern
- Address the U.S. government's need for access to safe, secure, and domestically produced chips

In addition, applicants should specifically discuss the following aspects of their project as outlined in section IV.I.5 of the NOFO:

- Cybersecurity
- Supply Chain Resilience and Risk Management
- Foreign Control

Required File Upload

[Upload Files](#) Or drop files

Upload one PDF that addresses instructions above

Optional File Upload

[Upload Files](#) Or drop files

Upload additional or supporting documents

File Name



Upload Date

Required



# Commercial Strategy

## Commercial Strategy

Commercial Strategy 0/1 0

For each proposed project, provide a description of the commercial strategy in no more than 15 pages (excluding supporting attachments and appendices) including, but not limited to, information on customer and end-market demand, volume growth, pricing dynamics, competitive positioning, and supply dynamics. This section should describe the following topics:

- **End-Market Demand:** Information on end market industries and projected growth, level of obsolescence risk, evidence of any pre-purchase commitments to demonstrate customer demand or other evidence of specific customer demand. Include explicit reference to the top 10 customers for each major product and associated volumes (to the extent known).
- **Market Position and Competitor Landscape:** Include an assessment of key competitors, market dynamics, supply and demand dynamics over time, pricing trends and exposure to pricing pressure during downturns and periods when there is an oversupply of semiconductors.
- **Stability of Supplies and Materials:** Include strategies to ensure stable and predictable sources of supplies and materials required as feedstock over the long run, including potential long-term contracts with suppliers and stress testing of the supplier network.
- **Improvement plans:** Describe existing plans as well as resourcing for continued investment in facility upgrades and improvements.

In addition, please attach any supporting documents that may be relevant to demonstrate commercial viability of the project(s).

**Required File Upload**

[Upload Files](#) Or drop files Upload one PDF that addresses instructions above

**Optional File Upload**

[Upload Files](#) Or drop files Upload additional or supporting documents

File Name	Upload Date	Required
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# Financial Information

Financial Information				
▼	✗	Detailed Description of Financial Plan	0/1	0
▼	✗	Project Sources and Uses of Funds	0/1	0
▼	✗	Project Cash Flow, Income Statement, and Balance Sheet Projections and Relevant Metrics for each Project	0/1	0
▼	✗	Scenario Analysis	0/1	0
▼	✗	CHIPS Incentives Request Template	0/1	0
▼	✗	CHIPS Incentives Request Narrative	0/1	0
▼	🚩	CHIPS Loan or Loan Guarantee Request		0
Project Technical Feasibility				
▼	✗	Description	0/1	0
▼	✗	Environmental Questionnaire	0/1	0



For each project in the application, provide a detailed description of the financial plan, in no more than 20 pages (excluding attachments and appendices).

The plan(s) should include the following, as outlined in Section IV.I.7 in the NOFO:

- Sources and uses of funds
- Cash flow projections
- Key equity return and debt service metrics
- CHIPS incentives request
- Sensitivity analyses

The applicant should also provide supporting evidence for any key assumptions used.

Note: Applicants should provide Microsoft Excel and PDF attachments to the greatest extent feasible to support the information requested in the Financial Information section. In particular, the financial statements, project cash flows, and sensitivity analyses should be in the format of a dynamic, integrated spreadsheet in Microsoft Excel. The program should permit variable inputs to the key assumptions and clearly identify key inputs and assumptions in the model. Applicant and project-level financials should be prepared in accordance with Generally Accepted Accounting Principles or comparable standards (e.g., International Financial Reporting Standards). The income statement, balance sheet, and statement of cash flows should be linked, and the sensitivity analyses should be included as scenarios within the model.

Required File Upload

Upload Files Or drop files

Upload one PDF that addresses instructions above

Optional File Upload

Upload Files Or drop files

Upload additional or supporting documents

File Name	Upload Date	Required	
CHIPS-000886-FIDetailedFinPlan-Sources and Instruction Guide-20230530	5/30/2023	✓	



## Financial Information

▼		Detailed Description of Financial Plan	1/1	0
▲		Project Sources and Uses of Funds	1/1	0

Download the Full Application Sources and Uses of Funds Excel template here, <https://www.nist.gov/document/chips-nofo-commercial-fabrication-facilities-full-application-offline-template-sources-and>, and upload a completed template. Instructions for how to complete the template are located here: <https://www.nist.gov/document/chips-nofo-commercial-fabrication-facilities-sources-and-uses-funds-instructions>.

If the application proposes multiple projects, project costs and capital sources should be provided cumulatively for the entire set of proposed projects and for each project individually.

Refer to section IV.I.7 of the NOFO for more information.

Note: Applicants should provide Microsoft Excel and PDF attachments to the greatest extent feasible to support the information requested in the Financial Information section. In particular, the financial statements, project cash flows, and sensitivity analyses should be in the format of a dynamic, integrated spreadsheet in Microsoft Excel. The program should permit variable inputs to the key assumptions and clearly identify key inputs and assumptions in the model. Applicant and project-level financials should be prepared in accordance with Generally Accepted Accounting Principles or comparable standards (e.g., International Financial Reporting Standards). The income statement, balance sheet, and statement of cash flows should be linked, and the sensitivity analyses should be included as scenarios within the model.

Link to Full Application Sources and Uses template available here: <https://www.nist.gov/document/chips-nofo-commercial-fabrication-facilities-full-application-offline-template-sources-and>

### Required File Upload


 Upload Files Or drop files

Upload one Excel file that addresses instructions above

### Optional File Upload

 Upload Files Or drop files

Upload additional or supporting documents

File Name	▼	Upload Date	Required	
CHIPS-000886-FISourcesAndUses-Sources and Instruction Guide-20230530		5/30/2023	✓	



For each project, provide a model displaying cash flow, income statement, and balance sheet projections, as well as relevant metrics in the form of a Microsoft Excel model with formulas. A white paper for the full application can be found at this link for reference: <https://www.nist.gov/document/chips-nofo-commercial-fabrication-facilities-guiding-principles-full-application-financial>. Each model should include the following, as outlined in Section IV.I.7. in the NOFO:

- Detailed Cash Flow Projections for the Project: Provide the cash flow projections on a levered and unlevered basis (as applicable). Provide quarterly cash flows through the first year of cash flow breakeven and then annually thereafter through the end of the facility's useful life. See NOFO section IV.I.7. for more detail on cash flows that should be included.
- Project Income Statement Projections: Quarterly income statement projections through the first year of cash flow breakeven and then annually thereafter through the lifetime of the facility, including relevant cash flow items noted above as well as other items such as depreciation and amortization.
- Project Balance Sheet Projections: Quarterly balance sheet projections through the first year of cash flow breakeven and then annually thereafter through the lifetime of the facility.
- IRR: Project IRR on a levered and unlevered basis.
- Key Project Financial Performance Metrics: Include summary metrics such as gross margin, EBITDA margin, EBIT margin, return on equity, return on assets, among other relevant metrics over time.
- Key Project Risk and Debt Service Metrics: Include summary debt servicing related metrics such as Debt/Equity, Debt Service Coverage Ratio (DSCR), Debt/EBITDA, interest coverage, and asset coverage ratios over time.

Note: Applicants should provide Microsoft Excel and PDF attachments to the greatest extent feasible to support the information requested in the Financial Information section. In particular, the financial statements, project cash flows, and sensitivity analyses should be in the format of a dynamic, integrated spreadsheet in Microsoft Excel. The program should permit variable inputs to the key assumptions and clearly identify key inputs and assumptions in the model. Applicant and project-level financials should be prepared in accordance with Generally Accepted Accounting Principles or comparable standards (e.g., International Financial Reporting Standards). The income statement, balance sheet, and statement of cash flows should be linked, and the sensitivity analyses should be included as scenarios within the model.

Link to financial model whitepaper available here: <https://www.nist.gov/document/chips-nofo-commercial-fabrication-facilities-guiding-principles-full-application-financial>

For applications with multiple projects, upload one required document in the "Required Upload" section and upload remaining required documents in the "Optional Upload" section

Required File Upload

Upload Files Or drop files

Upload one Excel file that addresses instructions above

Optional File Upload

Upload Files Or drop files

Upload additional or supporting documents

File Name	Upload Date	Required
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Provide a narrative summary of the financial resilience of each project by illustrating project cash flows, income statements and balance sheets, and key profitability metrics, IRR, and risk and debt service metrics under a plausible range of scenarios over the estimated useful life of the facility. Sensitivities should be shown in both the upside and downside cases. Sensitivity analyses should be included as scenarios within the model(s). See NOFO Section IV.I.7. for examples of sensitivities to include.

Note: Applicants should provide Microsoft Excel and PDF attachments to the greatest extent feasible to support the information requested in the Financial Information section. In particular, the financial statements, project cash flows, and sensitivity analyses should be in the format of a dynamic, integrated spreadsheet in Microsoft Excel. The program should permit variable inputs to the key assumptions and clearly identify key inputs and assumptions in the model. Applicant and project-level financials should be prepared in accordance with Generally Accepted Accounting Principles or comparable standards (e.g., International Financial Reporting Standards). The income statement, balance sheet, and statement of cash flows should be linked, and the sensitivity analyses should be included as scenarios within the model.

For applications with multiple projects, upload one required document in the "Required Upload" section and upload remaining required documents in the "Optional Upload" section

Required File Upload

Upload Files Or drop files

Upload one PDF that addresses instructions above

Optional File Upload

Upload Files Or drop files

Upload additional or supporting documents

File Name	Upload Date	Required	
CHIPS-000886-FIScenarioAnalysis-Sources and Instruction Guide-20230530	5/30/2023	✓	



Download the CHIPS Incentives Request Excel template for the full application here, <https://www.nist.gov/document/chips-nofo-commercial-fabrication-facilities-full-application-offline-incentives-request>, and upload a completed template. Information submitted in this form should correspond with figures uploaded in Sources & Uses of Funds template. Instructions for how to complete the template are located here: <https://www.nist.gov/document/chips-nofo-commercial-fabrication-facilities-incentives-request-instructions>. Also refer to Section IV.I.7. – “CHIPS Incentive Request” of the NOFO for specific requirements regarding the CHIPS incentive request for the full application.

Note: Applicants should provide Microsoft Excel and PDF attachments to the greatest extent feasible to support the information requested in the Financial Information section. In particular, the financial statements, project cash flows, and sensitivity analyses should be in the format of a dynamic, integrated spreadsheet in Microsoft Excel. The program should permit variable inputs to the key assumptions and clearly identify key inputs and assumptions in the model. Applicant and project-level financials should be prepared in accordance with Generally Accepted Accounting Principles or comparable standards (e.g., International Financial Reporting Standards). The income statement, balance sheet, and statement of cash flows should be linked, and the sensitivity analyses should be included as scenarios within the model.

Link to CHIPS Incentives Request template available here: <https://www.nist.gov/document/chips-nofo-commercial-fabrication-facilities-full-application-offline-incentives-request>



Required File Upload

Upload Files

Optional File Upload

Upload Files

### Upload Files

Project Financials.docx

18 KB

1 of 1 file uploaded

Done

File Name	Upload Date	Required	
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CHIPS Incentives Request Narrative

0/1

0



CHIPS Loan or Loan Guarantee Request

0

In a narrative description:

- Provide a rationale for the CHIPS Incentives request.
- Provide a narrative description for how the financial information submitted for the project support a conclusion that the CHIPS Incentives requested will incentivize the applicant to make investments in facilities and equipment in the United States that would not occur in the absence of the incentives.
- Provide a description of how the CHIPS Incentives requested were sized based on cash flow modeling, IRR analysis, sensitivity analysis, and other applicable analyses. Explain why the request is appropriate based on expected risks and returns of the project, historical projects of similar nature, or other relevant market benchmarks. Provide a justification for why the projected IRR in the cash flow model is appropriate for a project of this type, scale, and risk profile.
- Provide a description of specific efforts to date to bring other capital (debt, state and local incentives, other private capital) into the project and how the CHIPS Incentives request would enable and not displace those other funding sources.

Note: Applicants should provide Microsoft Excel and PDF attachments to the greatest extent feasible to support the information requested in the Financial Information section. In particular, the financial statements, project cash flows, and sensitivity analyses should be in the format of a dynamic, integrated spreadsheet in Microsoft Excel. The program should permit variable inputs to the key assumptions and clearly identify key inputs and assumptions in the model. Applicant and project-level financials should be prepared in accordance with Generally Accepted Accounting Principles or comparable standards (e.g., International Financial Reporting Standards). The income statement, balance sheet, and statement of cash flows should be linked, and the sensitivity analyses should be included as scenarios within the model.

Required File Upload

[Upload Files](#) Or drop files

Upload one PDF that addresses instructions above

Optional File Upload


[Upload Files](#) Or drop files

Upload additional or supporting documents

File Name	Upload Date	Required

# Project Technical Feasibility

### Project Technical Feasibility

^		Description	0/1	0
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The applicant must demonstrate the technical feasibility of each proposed project, which includes the viability and security of the underlying technology and manufacturing processes; the ability to execute required construction; and effective management of the environmental review process. Provide a detailed description of these topics in no more than 20 pages for each proposed project and include attachments to support details where relevant (which will be excluded from the page limit). The document should discuss at a minimum the following topics, as outlined in Section IV.I.8 of the NOFO:

- Technology and Manufacturing Processes
- Construction Plan
- Environmental Questionnaire and Information

Required File Upload

Or drop files

Upload one PDF that addresses instructions above


Optional File Upload

Or drop files





Upload additional or supporting documents

File Name	Upload Date	Required
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Environmental Questionnaire

^		Environmental Questionnaire	0/1	0
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### Financial Information

▼		Detailed Description of Financial Plan	1/1	0
▼		Project Sources and Uses of Funds	1/1	0
▼		Project Cash Flow, Income Statement, and Balance Sheet Projections and Relevant Metrics for each Project	1/1	0
▼		Scenario Analysis	1/1	0
▼		CHIPS Incentives Request Template	1/1	0
▼		CHIPS Incentives Request Narrative	1/1	0
▼		CHIPS Loan or Loan Guarantee Request		0

### Project Technical Feasibility

▼		Description	1/1	0
▼		Environmental Questionnaire	1/1	0

# Organization Information

Organization Information			
▼	✕	Ownership, Legal Entity, and Organizational Structure	0/1 0
▼	✕	Managerial Capability	0/1 0
▼	🚩	Consortium Applicants	0
▼	✕	Past Project History	0/1 0
▼	✕	Intellectual Property Security	0/1 0
▼	✕	Litigation and/or Conflicts	0/1 0
▼	✕	Advisors and Key Partners	0/1 0
Workforce Development Plan			
▼	✕	Workforce Development Plan	0/1 0

Organization Information								
▲	✕	Ownership, Legal Entity, and Organizational Structure 0/1 0						
<p>Provide formal legal entity and organizational structure detailing all of the applicant's parent companies, subsidiaries, and affiliates and other relevant entities, including associated ownership of those entities, up to the top shareholder(s) and the ultimate corporate parent (if applicable). In addition, outline recent and upcoming organizational changes, including mergers and acquisitions and any recent or proposed changes to corporate structure. Applicant should provide this information in the form of detailed charts and accompanying narrative explaining the legal entity and organizational structure.</p>								
<p>Required File Upload</p> <p><input type="button" value="Upload Files"/> Or drop files</p> <p>Upload one PDF that addresses instructions above</p>								
<p>Optional File Upload</p> <p><input type="button" value="Upload Files"/> Or drop files</p> <p>Upload additional or supporting documents</p>								
<table border="1"><thead><tr><th>File Name</th><th>Upload Date</th><th>Required</th></tr></thead><tbody><tr><td colspan="3">◀</td></tr></tbody></table>			File Name	Upload Date	Required	◀		
File Name	Upload Date	Required						
◀								



### Organization Information

▼		Ownership, Legal Entity, and Organizational Structure	1/1	0
▲		Managerial Capability	0/1	0

Provide a description of the approach to managerial oversight and governance of the project(s) from construction through the life of the facility. Include an organizational chart of management and other key personnel, including contractors and any other entities that will play substantial roles. List the experience and qualifications of key management personnel, including experience with projects of similar size and scope. Include one-page resumes for (a) all key management personnel and (b) all key personnel of contractors and any other entities that will play substantial roles in the project.

#### Required File Upload

Upload Files Or drop files

Upload one PDF that addresses instructions above

#### Optional File Upload

Upload Files Or drop files

Upload additional or supporting documents

File Name	▼	Upload Date	Required
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### Organization Information

▼		Ownership, Legal Entity, and Organizational Structure	1/1	0
▼		Managerial Capability	1/1	0
▼		Consortium Applicants		0
▲		Past Project History	1/1	0

Provide a summary for each of any comparable facilities commissioned by the applicant or its parent companies in the last ten years, including details on type of production and output, years in operation, location, project cost, and summary financials. Summary financials should include project IRR, and other relevant risk and return metrics.

#### Required File Upload

Upload Files Or drop files

Upload one PDF that addresses instructions above

#### Optional File Upload

Upload Files Or drop files

Upload additional or supporting documents

File Name	▼	Upload Date	Required
CHIPS-000886-OIPastProjectHist-Supplemental Questions-20230530		5/30/2023	
◀			



Past Project History

1/1

0



Intellectual Property Security

1/1

0

Provide policies and procedures to combat cloning, counterfeiting, and relabeling of semiconductors, as applicable, as well as protecting semiconductor designs and other intellectual property associated with the manufacture of semiconductors.

Required File Upload

Upload Files Or drop files

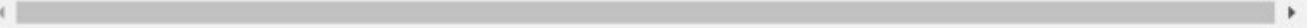
Upload one PDF that addresses instructions above

Optional File Upload

Upload Files Or drop files

Upload additional or supporting documents

File Name	Upload Date	Required	
CHIPS-000886-OIIntelPropSec-Supplemental Questions-20230530	5/30/2023	✓	



Litigation and/or Conflicts

1/1

0

Disclose current, threatened (in writing), or pending litigation, or criminal or civil government investigations involving the applicant, its corporate parents, or, to the applicant's knowledge, any other relevant party, related to permitting, public involvement, environmental issues, construction defects, intellectual property, fraud, securities fraud, conflict of interest, failure to perform under a local, state or Federal contract, or other charges which may reflect on the applicant's trustworthiness, financial position, or ability to complete the project(s).

Required File Upload

Upload Files Or drop files

Upload one PDF that addresses instructions above

Optional File Upload

Upload Files Or drop files

Upload additional or supporting documents

File Name	Upload Date	Required	
CHIPS-000886-OILitigationConflict-Project Plan Summary-20230530	5/30/2023	✓	





For the purpose of assisting the Department in complying with government ethics rules, the applicant should provide a list of the following:

1. advisors who will represent the applicant before the Department in connection with its application, identifying the advisory services provided.
2. any partner named elsewhere in the application (e.g. contractor, investor in the project, workforce training partner, etc.), and identify the section(s) of the application in which the entity is named.

Required File Upload

Upload Files Or drop files

Upload one PDF that addresses instructions above

Optional File Upload

Upload Files Or drop files

Upload additional or supporting documents

File Name	Upload Date	Required	
CHIPS-000886-OIPartners-Key Assumptions-20230530	5/30/2023	✓	

# Workforce Development Plan

## Workforce Development Plan

Workforce Development Plan 1/1 0

Provide documentation, in no more than 30 pages (excluding supporting attachments and appendices), for the expected workforce needs for each facility and provide a strategy to meet such needs in a workforce development plan. Also provide a workforce plan for the construction workforce. Identify the overall financial resources that will be committed to these efforts by the applicant and other parties across the workforce system, partners involved in the effort, and what those resources will be used for detailed by category, though CPO understands that the level of detail may vary depending on the stage of the development of a sector partnership or workforce development planning. The upload should include the following (Refer to NOFO section IV.1.10 for more details on requirements):

- Facility Workforce Plan
- Construction Workforce Plan
- Childcare requirement information (for applicants requesting CHIPS Direct Funding over \$150 million)

In addition to the required summary, please attach any supporting documents that may be relevant to workforce development plans for the project(s).

**Required File Upload**

Or drop files

Upload one PDF that addresses instructions above

**Optional File Upload**

Or drop files

Upload additional or supporting documents

File Name	Upload Date	Required	
CHIPS-000886-WDPDescription-Project Financials-20230530	5/30/2023	✓	<input type="button" value="Delete"/>

Broader Impacts

Organization Information				
▼	✓	Ownership, Legal Entity, and Organizational Structure	1/1	0
▼	✓	Managerial Capability	1/1	0
▼	⚠	Consortium Applicants		0
▼	✓	Past Project History	1/1	0
▼	✓	Intellectual Property Security	1/1	0
▼	✓	Litigation and/or Conflicts	1/1	0
▼	✓	Advisors and Key Partners	1/1	0
Workforce Development Plan				
▼	✓	Workforce Development Plan	1/1	0

### Broader Impacts

Broader Impacts				
▼	✗	Broader Impacts	0/1	0
Standard Forms				
▼	✗	SF-328, Certificate Pertaining to Foreign Interests	0/1	
▼	✗	CD-511, Certification Regarding Lobbying	0/1	
▼	⚠	SF-LLL, Disclosure of Lobbying Activities		0
▼	⚠	Other Forms		0

Save Progress
File Upload Complete
Required File Count: 23/26

**Broader Impacts**

Broader Impacts 0/1 0

Provide an overview, in no longer than 30 pages (excluding supporting attachments and appendices) of the broader impacts of the project(s), covering each of the following topics, as outlined in IV.I.11. of the NOFO:

- Commitments to Future Investment in the U.S. Semiconductor Industry (15 page maximum)
- Buyback commitment
- Support for Semiconductor Research & Development
- Creating Inclusive Opportunities for Businesses through a Supplier Diversity Plan
- Climate & Environmental Responsibility
- Community Investments
- Domestic Content

In addition to the required summary, please attach any supporting attachments and appendices that may be relevant to addressing this question.

Required File Upload

Upload Files Or drop files Upload one PDF that addresses instructions above

Optional File Upload

Upload Files Or drop files Upload additional or supporting documents

File Name	Upload Date	Required
←		

## Standard Forms

**Standard Forms**

SF-328, Certificate Pertaining to Foreign Interests 1/1

Please complete and upload SF-328, Certificate Pertaining to Foreign Interests. Link to form: <https://www.gsa.gov/forms-library/certificate-pertaining-foreign-interests>

Required File Upload

Upload Files Or drop files Upload one PDF that addresses instructions above

File Name	Upload Date	Required
CHIPS-000886-SF328-Project Financials-20230530	5/30/2023	✓
←		

## Standard Forms

- ▼  SF-328, Certificate Pertaining to Foreign Interests 1/1
- ▲  CD-511, Certification Regarding Lobbying 1/1

Please complete and upload CD-511, Certification Regarding Lobbying. Link to form:


<https://apply07.grants.gov/apply/forms/sample/CD511-V1.1.pdf>

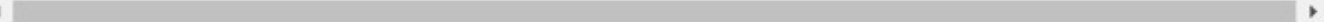
Enter "2023-NIST-CHIPS-CFF-01" in the Award Number field. Enter the title of the application, or an abbreviation of that title, in the Project Name field

Required File Upload

 Upload Files Or drop files

Upload one PDF that addresses instructions above

File Name	▼	Upload Date	Required	
CHIPS-000886-SFCD511-Sources and Instruction Guide-20230530		5/30/2023	✓	



SF-LLL, Disclosure of Lobbying Activities


1

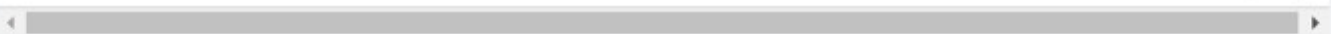
Please complete and upload SF-LLL, Disclosure of Lobbying Activities (if applicable). Link to form: <https://www.gsa.gov/forms-library/disclosure-lobbying-activities>

Optional File Upload

 Upload Files Or drop files

Upload one PDF that addresses instructions above

File Name	▼	Upload Date	Required	
CHIPS-000886-SFLLL-Supplemental Questions-20230530		5/30/2023		



### Broader Impacts

▼	✓	Broader Impacts	1/1	0
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### Standard Forms

▼	✓	SF-328, Certificate Pertaining to Foreign Interests	1/1	
▼	✓	CD-511, Certification Regarding Lobbying	1/1	
▼	✓	SF-LLL, Disclosure of Lobbying Activities		1
▼	⚠	Other Forms		0

Save Progress

File Upload Complete

Required File Count: 26/26



# Attestation & Submission

## Attest and Submit

The CHIPS Program Office (CPO) recognizes the importance of protecting confidential business information and will follow all applicable laws to protect such information, including, for example, the CHIPS Act, the Trade Secrets Act, and the Freedom of Information Act. Please refer to Section IV.C. of the CHIPS Incentives Program Commercial Fabrication Facilities Notice of Funding Opportunity (CHIPS-CFF NOFO) for a further discussion of these laws.

### Submission Certifications

Attestation
The individual submitting the Application certifies on behalf of the applicant entity that the applicant information and data submitted and the representations made in the Pre-Application are true, complete and accurate, to the best of the applicant's knowledge and belief after due inquiry.
<input checked="" type="checkbox"/>

Attestation
The individual submitting the Application certifies on behalf of the applicant that the applicant understands that CPO and the Department of Commerce will rely on the accuracy and completeness of the applicant information and data submitted and the representations made in the Application and that any false, fictitious or fraudulent statement or representation made in the Application may be the basis for rejection of the Application or subject the applicant to criminal, civil, or administrative penalties. (18 U.S. Code, Section 1001.)
<input checked="" type="checkbox"/>

Attestation
The individual submitting the Application certifies on behalf of the applicant that the applicant understands that any applicant information and data contained in the Application may be accessed and used by federal employees, consultants and contractors in accordance with CHIPS-CFF NOFO, Section IV.C. (Confidential Information).
<input checked="" type="checkbox"/>

## Steps

- Attest and Submit
- Generate PDF

(Attestation step 1)

Attestation

The individual submitting the Application certifies that they possess the full legal power and authority to submit the Application and make the preceding certifications on behalf of the applicant.



**Public Communications**

Attestation

The individual submitting the Application agrees that neither the applicant entity nor any of its affiliates may issue any press release or otherwise publicly disclose the status of the Pre-Application or the contents of any communications with CPO or the Department of Commerce without CPO's prior written consent.



Attestation

The individual submitting the Application certifies that they possess the full legal power and authority to bind the applicant.




MP Holdings  
Operator  
Mary Poppins

Next

(Attestation step 1 continued)

# Submissions



Home Resources User Support

Application Workspace Application Team **Submissions**

Filename ↑	Uploaded Date	Application Source	Download
CHIPS-000886-APCompanyFinancials-Key Assumptions-...	May 30, 2023	Full App	<a href="#">Download</a>
CHIPS-000886-APEquityCapitalStruc-Legal Entity and Or...	May 30, 2023	Full App	<a href="#">Download</a>
CHIPS-000886-APOutstandingDebt-Sources and Instruct...	May 30, 2023	Full App	<a href="#">Download</a>
CHIPS-000886-ApplicantDescription-Company Financial...	May 30, 2023	Full App	<a href="#">Download</a>
CHIPS-000886-BroaderImpacts-Project Financials-20230...	May 30, 2023	Full App	<a href="#">Download</a>
CHIPS-000886-CommercialStrategy-Cash Flow Model-20...	May 30, 2023	Full App	<a href="#">Download</a>
CHIPS-000886-CoveredIncentive-Cash Flow Model-2023...	May 30, 2023	Full App	<a href="#">Download</a>
CHIPS-000886-EconomicResilience-Legal Entity and Org ...	May 30, 2023	Full App	<a href="#">Download</a>
CHIPS-000886-FIDetailedFinPlan-Sources and Instructio...	May 30, 2023	Full App	<a href="#">Download</a>
CHIPS-000886-FIincentiveNarrative-Sources and Instruct...	May 30, 2023	Full App	<a href="#">Download</a>
CHIPS-000886-FIincentiveRequest-Project Financials-20...	May 30, 2023	Full App	<a href="#">Download</a>
CHIPS-000886-FIProjectInformation-Cash Flow Model-2...	May 30, 2023	Full App	<a href="#">Download</a>
CHIPS-000886-FIScenarioAnalysis-Sources and Instructi...	May 30, 2023	Full App	<a href="#">Download</a>
CHIPS-000886-FISourcesAndUses-Sources and Instructio...	May 30, 2023	Full App	<a href="#">Download</a>
CHIPS-000886-OIIntelPropSec-Supplemental Questions-...	May 30, 2023	Full App	<a href="#">Download</a>
CHIPS-000886-OILitigationConflict-Project Plan Summar...	May 30, 2023	Full App	<a href="#">Download</a>

(List of all submissions with Application Source of Full App)

# Full Application Submitted

Full Application

OMB Control Number: 0693-0094  
Expiration Date: 09/30/2023

[View Burden Statement](#)

Acknowledgement	SECTION STATUS Submitted	<a href="#">Submitted</a>
Cover Page	SECTION STATUS Submitted	<a href="#">Submitted</a>
Project Plan	SECTION STATUS Submitted	<a href="#">Submitted</a>
Sources and Uses	SECTION STATUS Submitted	<a href="#">Submitted</a>
CHIPS Incentive Request	SECTION STATUS Submitted	<a href="#">Submitted</a>
Workforce Development Information	SECTION STATUS Submitted	<a href="#">Submitted</a>
File Uploads	SECTION STATUS Submitted	<a href="#">Submitted</a>
Attestation & Submission	SECTION STATUS Submitted	<a href="#">Submitted</a>